



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-----------------|
| Chip Size | 0402 |
| L | 1mm +/-0.05mm |
| W | 0.5mm +/-0.05mm |
| T | 0.5mm +/-0.05mm |
| B | 0.25mm +/-0.1mm |

Packaging Specifications

| | |
|--------------------|-------|
| Packaging | T&R |
| Packaging Quantity | 10000 |

General Information

| | |
|-------------|---|
| Series | Z-PMS |
| Style | SMD Chip |
| Description | Chip Bead, Power Line |
| Features | Suppresses The XL Component; Helps Stop The Reduction Of The Wave-Form Integrity |
| RoHS | Yes |
| Notes | Suggested Replacement - https://productfinder.pulseelectronics.com/part/BBPY00100505100Y00 . |

Specifications

| | |
|---------------------|-------------------|
| Impedance | 10 Ohms (100 MHz) |
| Impedance Tolerance | 25% |
| Ripple Current | 2000 mA (MAX) |
| Temperature Range | -55/+85°C |
| DC Resistance | 0.03 Ohms |